JMT120KT16T1

Thyristor Module

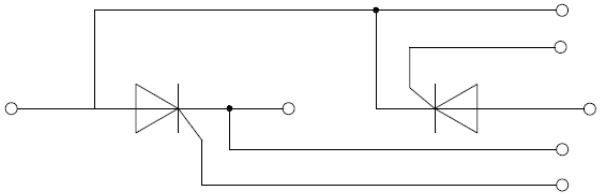
Features

- Half-bridge SCR configuration integrated ina singl package
- High-thermal-conductivity DBC insulation for excellent heat dissipation
- Vacuum soldering technology for enhanced reliability

Parameter	Value	Unit
V_{RRM}	1600	V
$I_{T(AV)}$(@ T_C = 85℃)	120	A
I_{TSM}(@ t_P = 10ms)	2500	A
V_T(Max)	1.80	V

Applications

- Heating control
- Light control system
- DC motor



Absolute Maximum Ratings (@ T_C = 25°C unless otherwise specified)

Parameter	Conditions	Symbol	Values	Unit
Repetitive peak off-state voltage	Tvj = 25°C	V_{DRM}	1600	V
Repetitive peak reverse voltage	Tvj = 25°C	V_{RRM}	1600	V
Non-repetitive peak off-state voltage	Tvj = 25°C	V_{DSM}	1700	V
Non-repetitive peak reverse voltage	Tvj = 25°C	V_{RSM}	1700	V
Average forward current	T_C = 85°C	$I_{T(AV)}$	120	A
Forward surge current	1/2 cycle, Sine wave, 50Hz Tvj = 25℃	I_{TSM}	2500	A
I^2t value for fusing		I^2t	31250	A^2s
Critical rate of rise of on-state current	I_G=2×I_{GT}	di/dt	150	A/μs
RMS isolation voltage	A.C 50Hz(1s/1min)	V_{ISO}	3600/3000	V
Junction temperature range		T_J	-40 ~ +125	℃
Storage temperature range		T_{stg}	-40 ~ +125	℃

Electrical Characteristics (@ T_C = 25°C unless otherwise specified)

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Peak forward voltage	I_T=360A, t_P=380μs	V_T			1.80	V
Repetitive peak off-state current	V_D = V_{DRM},T_{vj} = 25℃	I_{DRM}			100	μA
	V_D = V_{DRM},T_{vj} = 125℃				40	mA
Reverse leakage current	V_R = V_{RRM},T_{vj} = 25℃	I_{RRM}			100	μA
	V_R = V_{RRM},T_{vj} = 125℃				40	mA
Threshold voltage	For power loss calculation only T_{vj} = 125℃,	V_{TO}			0.9	V
Dynamic resistance	T_{vj} = 125℃,	r_T			2	mΩ
Triggering gate current	V_D=12V R_L=30Ω	I_{GT}	20		120	mA
Holding current	I_T=1A	I_H			250	mA
Latching current	I_G=1.2 I_{GT}	I_L			300	mA
Critical rate of rise of voltage	V_D=2/3V_{DRM} Tvj=125℃ Gate Open	dv/dt	1000			V/μs
Triggering gate voltage	V_D=12V R_L=30Ω	V_{GT}			1.8	V
Non triggering gate voltage	V_D=0.5V_{DRM} Tvj=125℃	V_{GD}	0.25			V

Thermal Characteristics (@ T_C = 25°C unless otherwise specified)

Parameter	Conditions	Symbol	Values			Unit
			Min.	Typ.	Max.	
Thermal resistance, junction to case	per Thyristor	$R_{th(j-c)}$		0.225		℃/W
Thermal resistance, case to heatsink	per Thyristor	$R_{th(c-s)}$		0.12		℃/W
Mounting torque	Module and heatsink fixed torque M5	M	4.25		5.75	N·m
	Electrode connection torque M5		2.55		3.45	N·m

Ordering Information

Device	Marking	Package	Weight	Inner Box	Pre Carton
JMT120KT16T1	JMT120KT16T1	T1	100±5g/PCS	10 PCS	120 PCS

Typical Electrical & Thermal Characteristics

FIG.1: Power dissipation vs. on-state current (per thyristor or diode)

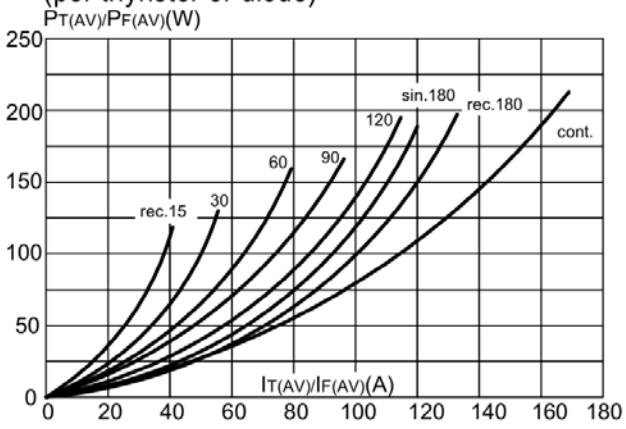


FIG.2: Maximum transient thermal impedance junction to case(per thyristor or diode)

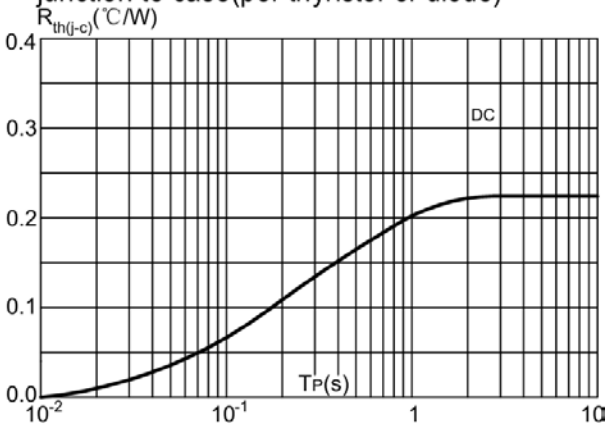


FIG.3: Forward characteristics (per thyristor or diode)

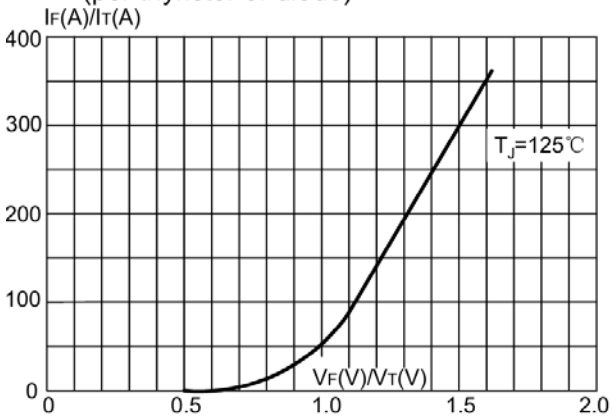
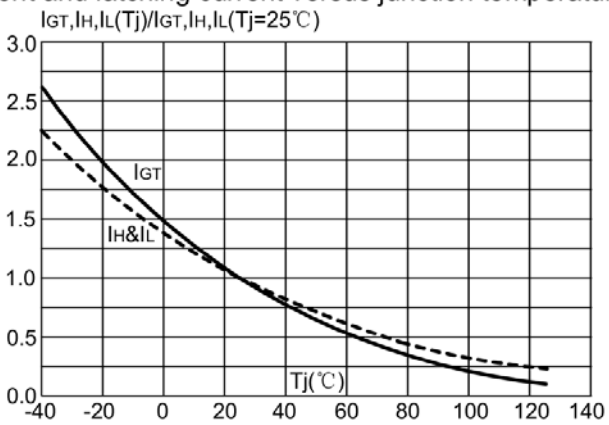
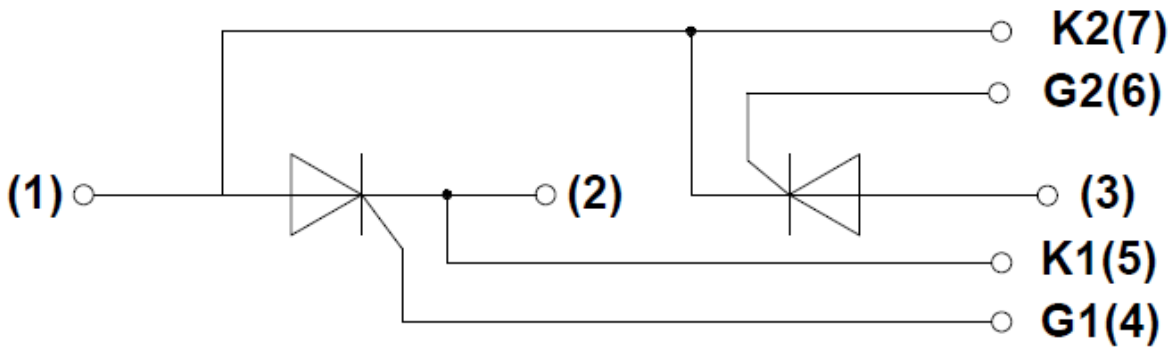


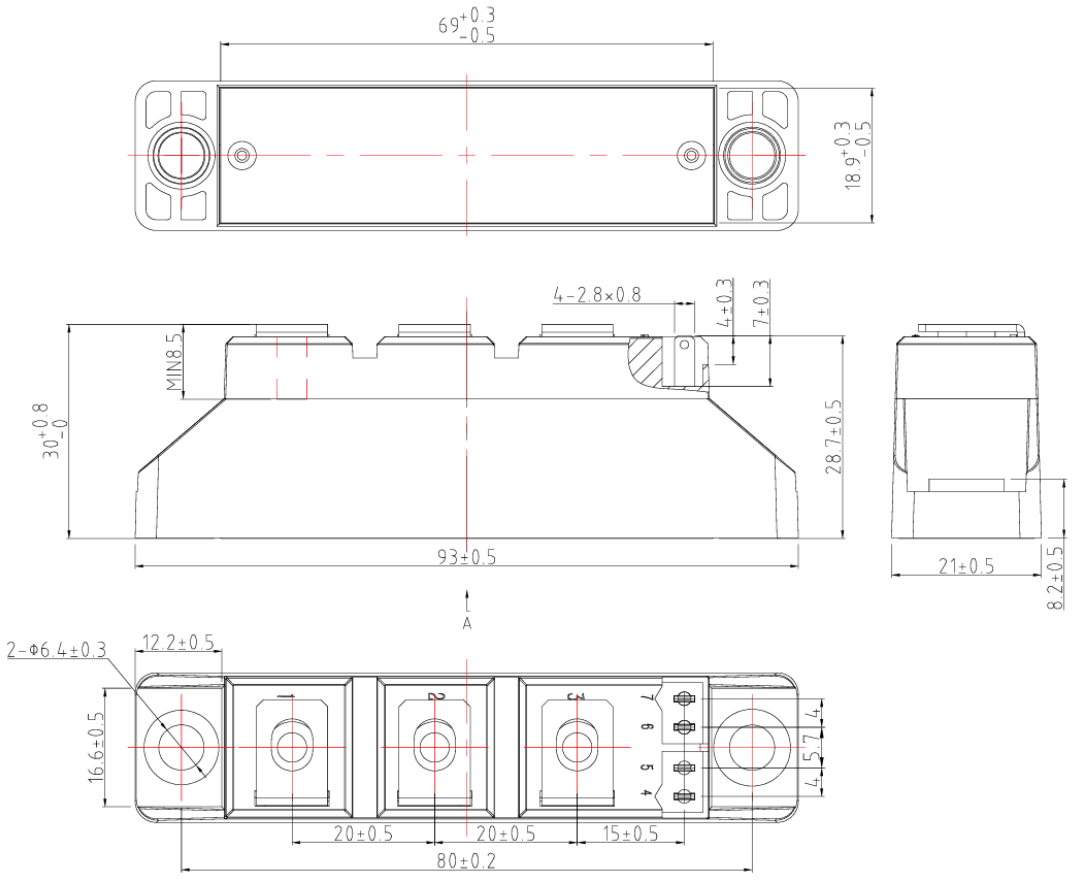
FIG.4: Relative variations of gate trigger current, holding current and latching current versus junction temperature



Circuit Diagram



Package Outlines (mm)



Unit of measurement: mm

Information furnished in this document is believed to be accurate and reliable. However, Jiangsu JieJie Semiconductor Co., Ltd assumes no responsibility for the consequences of use without consideration for such information nor use beyond it. This information in this document is subject to change without prior notice. Notwithstanding this, Jiangsu JieJie will fully comply with the terms outlined in a signed agreement. Products and information provided in this document have no infringement of patents. Jiangsu JieJie assumes no responsibility for any infringement of other rights of third parties which may result from the use of such products and information. This document is the initial release, dated 18 March 2026. This document supersedes and replaces all information previously supplied.